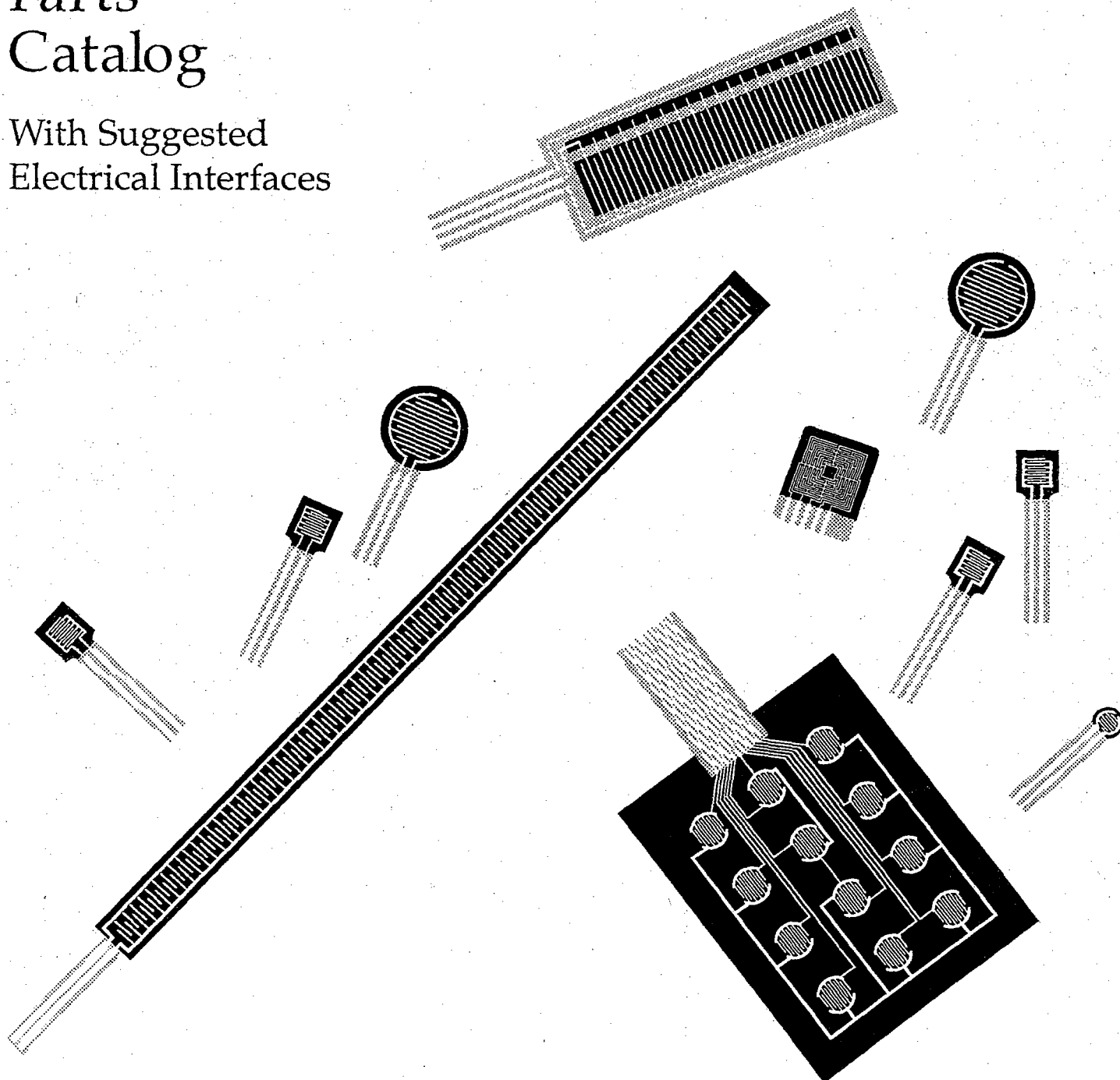


FSRTM Integration Guide & Evaluation Parts Catalog

With Suggested
Electrical Interfaces


INTERLINK
ELECTRONICS



FSR™ Evaluation Parts Price List and Order Form

INTERLINK ELECTRONICS
546 Flynn Road
Camarillo, CA 93012

400
402
406
1.5
408
240
500

Qty.	Model #	Part Description	1 - 99	100 - 999	1000+	Line Total
	300B	0.2" circle on Stabar™ with solderable tabs	\$3.50	\$3.00	\$2.50	
	300C	0.2" circle on Stabar™ with housed female connector	\$4.00	\$3.50	\$3.00	
	301B	0.25" square on Ultem™ with solderable tabs	\$3.50	\$3.00	\$2.50	
	301C	0.25" square on Ultem™ with housed female connector	\$4.00	\$3.50	\$3.00	
	302B	0.5" circle on Ultem™ with solderable tabs	\$4.00	\$3.40	\$2.75	
	302C	0.5" circle on Ultem™ with housed female connector	\$4.50	\$3.90	\$3.25	
	303B	0.5" circle on Stabar™ with solderable tabs	\$4.00	\$3.40	\$2.75	
	303C	0.5" circle on Stabar™ with housed female connector	\$4.50	\$3.90	\$3.25	
	304B	0.875" circle on Ultem™ with solderable tabs	\$4.50	\$3.90	\$3.25	
	304C	0.875" circle on Ultem™ with housed female connector	\$5.00	\$4.40	\$3.75	
	306B	1.5" square on Ultem™ with solderable tabs	\$5.50	\$4.60	\$3.75	
	306C	1.5" square on Ultem™ with housed female connector	\$6.00	\$5.10	\$4.25	
	308B	24" x 0.2" strip (0.6" part width) on Stabar™ with solderable tabs	\$12.50	\$9.50	\$6.50	
	308C	24" x 0.2" strip (0.6" part width) on Stabar™ with hs'd female connector	\$13.00	\$10.00	\$7.00	
	360B	4.0" Linear Potentiometer on Ultem™ with solderable tabs	\$8.00	\$7.00	\$5.50	
	360C	4.0" Linear Potentiometer on Ultem™ with housed female connector	\$8.50	\$7.50	\$6.00	
	S180	FSR Design Kit (see contents below)	\$79.95			

The FSR Design Kit contains the following items:

- Three each of sensor types: 300, 301, 302, 303, 304, 306
- One each of sensor types: 308 and 360
- Two 2-pin male wire harnesses.
- An assortment of overlays and adhesives.

• FSR Integration Guide and Evaluation Parts Catalog and TechNotes: Suggested Interfaces.

Minimum Order is \$60.00. Sub-total
(\$10 USA/\$75 International) Shipping
(If CA, add tax at your rate) % Sales Tax
6.00
10. Spring
TOTAL

Product Support:
805/484/1331

Fax:
805/484/8989

All sensor dimensions refer to active sensing area. Please refer to FSR Integration Guide and Evaluation Parts Catalog for detailed dimensions. FSRs with an adhesive on one or both sides are available. Please call Product Support for more information. All prices subject to revision without notice; all product shipped FOB Camarillo, CA. All purchases subject to the Terms and Conditions on the back of this form.
Interlink Electronics holds international patents for its Force Sensing Resistor device technology. FSR, Force Sensing Resistor, Interlink and the six dot logo type are trademarks of Interlink Electronics. Other brand and product names are trademarks of their respective holders.

Method of Payment

☐ Check enclosed
☐ Master Card ☐ Visa ☐ American Express
Card #
Exp. Date
Signature

Name _____ Company _____
Use or application for FSR _____
Address _____
City _____ State _____ Zip _____
Country _____
Phone _____ Fax _____

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17. **Security Interest.** In the case of sales made on credit, Buyer grants Interlink a purchase money security interest in products and any proceeds thereof, as security for Buyer's obligation to pay the purchase price, and Buyer agrees to execute any financing statement or other instrument reasonably required by Buyer to perfect such security interest.
18. **Waiver.** No waiver of any violation or nonperformance of this agreement in one instance shall be deemed to be a waiver of any subsequent violation or nonperformance. All waivers must be in writing.
19. **Severability.** If one or more provisions of this agreement are held to be unenforceable under applicable law, such provision shall be excluded from this agreement and the balance of this agreement shall be enforceable in accordance with its terms.

INTERLINK ELECTRONICS

BUYER: _____

By: _____

By: _____

Its: _____ Date: _____

Its: _____ Date: _____

FSR™ Integration Guide & Evaluation Parts Catalog With Suggested Electrical Interfaces

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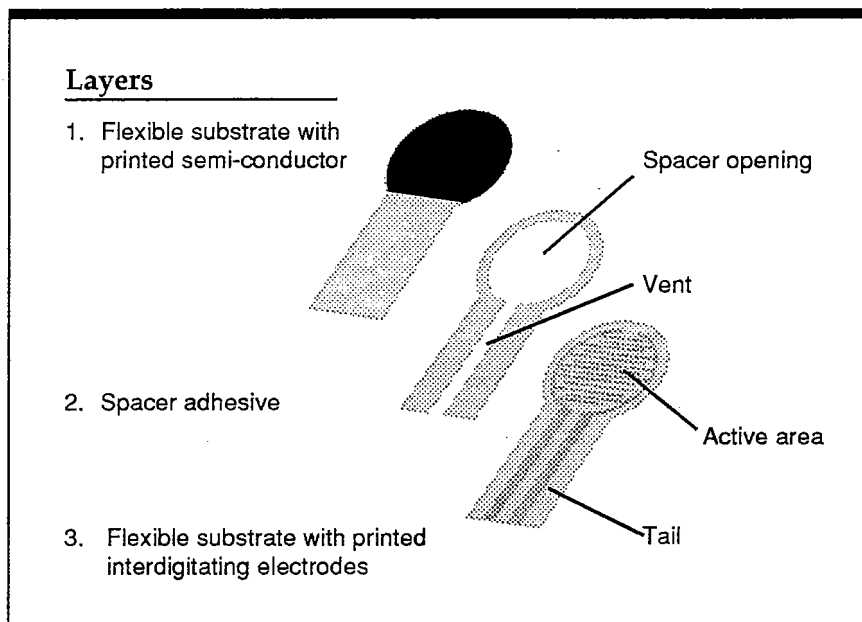
Interlink Electronics manufactures custom FSR devices to meet the needs of specific customer applications. FSR devices can be produced in almost any shape, size, and geometry. Additionally, FSRs can be integrated with other flexible film and flat panel technologies, such as electroluminescent and fiber-optic backlighting, flexible LCDs, and flat or embossed graphic overlays. To discuss a custom design or to obtain a quote, contact Interlink Electronics at (805) 484-1331.

Force Sensing Resistors

An Overview of the Technology

Force Sensing Resistors (FSR) are a polymer thick film (PTF) device which exhibits a decrease in resistance with an increase in the force applied to the active surface. Its force sensitivity is optimized for use in human touch control of electronic devices. FSRs are not a load cell or strain gauge, though they have similar properties. FSRs are not suitable for precision measurements.

FSR Construction



Force vs. Resistance

The force vs. resistance characteristic shown in Figure 1 provides an overview of FSR typical response behavior. For interpretational convenience, the force vs. resistance data are plotted on a log/log format. These data are representative of our typical devices, with this particular force-resistance characteristic being the response of evaluation part # 302 (0.5" [12.7 mm] diameter circular active area). A stainless steel actuator with a 0.4" [10.0 mm] diameter hemispherical tip of 60

durometer polyurethane rubber was used to actuate the FSR device. In general, FSR response approximately follows an inverse power-law characteristic (roughly $1/R$).

Referring to Figure 1, at the low force end of the force-resistance characteristic, a switch-like response is evident. This turn-on threshold, or "break force", that swings the resistance from greater than $1\text{ M}\Omega$ to about $100\text{ k}\Omega$ (the beginning of the dynamic range that follows a power-law) is determined by the substrate and overlay thickness and flexibility, size and shape of the actuator, and spacer-adhesive thickness (the gap between the facing conductive elements). Break force increases with increasing substrate and overlay rigidity, actuator size, and spacer-adhesive thickness. Eliminating the adhesive, or keeping it well away from the area where the force is being applied, such as the center of a large FSR device, will give it a lower rest resistance (e.g. stand-off resistance). Any pre-loading of a FSR will also yield the same result.

Force vs. Resistance

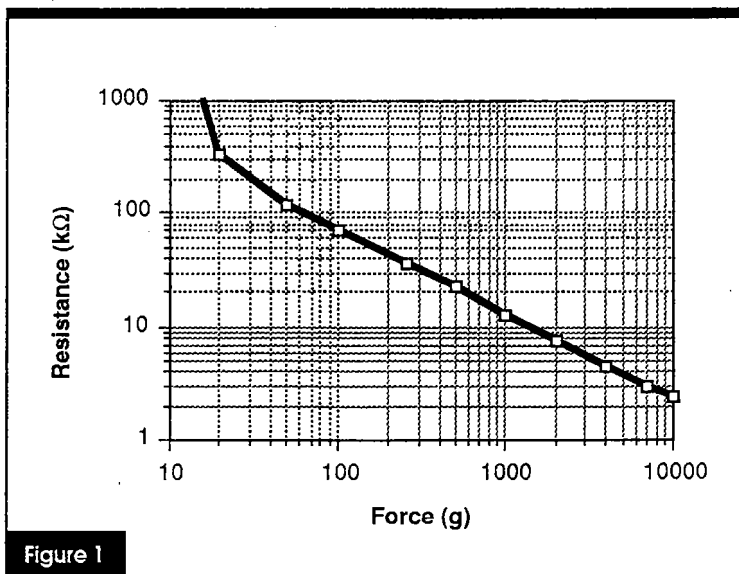


Figure 1

At the high force end of the dynamic range, the response deviates from the power-law behavior, and eventually saturates to a point where increases in force yield little or no decrease in resistance. Under the test conditions of Figure 1, this saturation force is beyond 10 kg. The saturation point is more a function of pressure than force. The saturation pressure of a typical FSR is on the order of 100 to 200 psi. For the data shown in Figures 1, 2 and 3, the actual measured pressure range is 0 to 175 psi (0 to 22 lbs applied over 0.125 in²). Forces higher than the saturation force can be measured by spreading the force over a greater area; the overall pressure is then kept below the saturation point, and dynamic response is maintained. However, the converse of this effect is also true, smaller actuators will saturate FSRs earlier in the dynamic range, since the saturation point is reached at a lower force.

Force vs. Conductance

In Figure 2, the force is plotted vs. conductance (the inverse of resistance: $1/R$). This format allows interpretation on a linear scale. For reference, the corresponding resistance values are also included on the right vertical axis. A simple circuit called a current-to-voltage converter (see page 20) gives a voltage output directly proportional to FSR conductance and can be useful where response linearity is desired. Figure 2 also includes a

typical part-to-part repeatability envelope. This error band determines the maximum accuracy of any general force measurement. The spread or width of the band is strongly dependent on the repeatability of any actuating and measuring system, as well as the repeatability tolerance held by Interlink Electronics during FSR production. Typically, the part-to-part repeatability tolerance held during manufacturing ranges from $\pm 15\%$ to $\pm 25\%$ of an established nominal resistance.

Figure 3 highlights the 0-1 kg (0-2.2 lbs) range of the force-conductance characteristic. As in Figure 2, the corresponding resistance values are included for reference. This range is common to human interface applications. Since the conductance response in this range is fairly linear, the force resolution will be uniform and data interpretation simplified. The typical part-to-part error band is also shown for this touch range. In most human touch control applications this error is insignificant, since human touch is fairly inaccurate. Human factors studies have shown that in this force range repeatability errors of less than $\pm 50\%$ are difficult to discern by touch alone.

Force vs. Conductance (0-10 Kg)

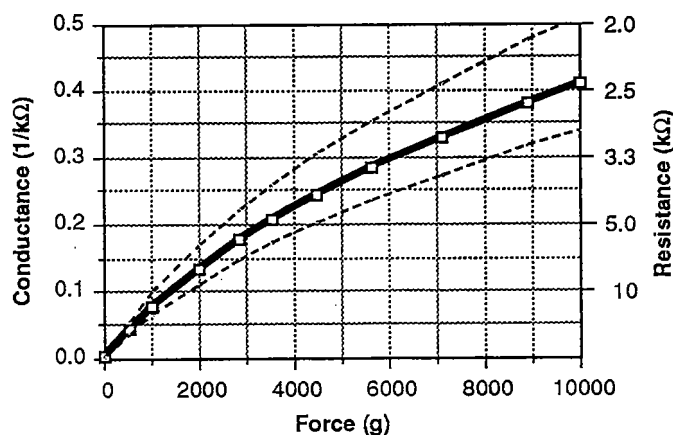


Figure 2

Force vs. Conductance (0-1 Kg) Low Force Range

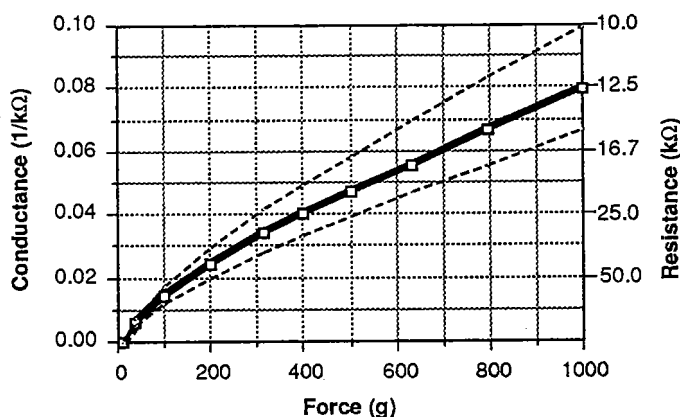


Figure 3

FSR Integration Notes

A Step-by-Step Guide to Optimal Use

For best results, follow these seven steps when beginning any new product design, proof-of-concept, technology evaluation, or first prototype implementation:

1. Start with Reasonable Expectations (Know Your Sensor).

The FSR sensor is not a strain gauge, load cell or pressure transducer. While it can be used for dynamic measurement, only qualitative results are generally obtainable. Force accuracy ranges from approximately $\pm 5\%$ to $\pm 25\%$ depending on the consistency of the measurement and actuation system, the repeatability tolerance held in manufacturing, and the use of part calibration. For force and position sensing Linear Potentiometers (LPs), positional accuracy is excellent, generally better than $\pm 1\%$ of full length.

Accuracy should not be confused with resolution. The force resolution of FSR devices is better than $\pm 0.5\%$ of full use force. The positional resolution of LPs range from 0.003" to 0.020", depending on the nature of the actuator used.

2. Choose the Sensor that Best Fits the Geometry of Your Application.

Usually sensor size and shape are the limiting parameters in FSR integration, so any evaluation part should be chosen to fit the desired mechanical actuation system. In general, standard FSR products have a common semiconductor make-up and only by varying actuation methods (e.g. overlays and actuator areas) or electrical interfaces can different response characteristics be achieved.

3. Set-up a Repeatable and Reproducible Mechanical Actuation System.

When designing the actuation mechanics, follow these guidelines to achieve the best force repeatability:

- **Provide a consistent force distribution.** FSR response is very sensitive to the distribution of the applied force. In general, this precludes the use of dead weights for characterization since exact duplication of the weight distribution is rarely repeatable cycle-to-cycle. A consistent weight (force) distribution is more difficult to achieve than merely obtaining a consistent total applied weight (force). As long as the distribution is the same cycle-to-cycle, then repeatability will be maintained. The use of a thin elastomer between the applied force and the FSR can help absorb error from inconsistent force distributions.
- **Keep the actuator area, shape, and compliance constant.** Changes in these parameters significantly alter the response characteristic of a given sensor. Any test, mock-up, or evaluation conditions should be closely matched to the final use conditions. The greater the cycle-to-cycle consistency of these parameters, the greater the device repeatability. In human interface applications where a finger is the mode of actuation, perfect control of these parameters is not generally possible. However, human force sensing is somewhat inaccurate; it is rarely sensitive enough to detect differences of less than $\pm 50\%$.
- **Control actuator placement.** In cases where the actuator is to be smaller than the FSR active area, cycle-to-cycle consistency of actuator placement is necessary. (Caution: FSR layers are held together by an adhesive that surrounds the electrically active areas. If force is applied over an area which includes the adhesive, the resulting response characteristic will be drastically altered.) In an extreme case (e.g., a large, flat, hard actuator that bridges the bordering adhesive), the adhesive can prevent FSR actuation.

- **Keep actuation cycle time consistent.** Because of the time dependence of the FSR resistance to an applied force, it is important when characterizing the sensor system to assure that increasing loads (e.g. force ramps) are applied at consistent rates (cycle-to-cycle). Likewise, static force measurements must take into account FSR mechanical settling time. This time is dependent on the mechanics of actuation and the amount of force applied and is usually on the order of seconds.
4. **Use the Optimal Electronic Interface.**
In most product designs, the critical characteristic is Force vs. Output Voltage, which is controlled by the choice of interface electronics. A variety of interface solutions are detailed in the TechNote section of this guide. Summarized here are some suggested circuits for common FSR applications.
 - **For FSR Pressure or Force Switches,** use the simple interfaces detailed on pages 18 and 19 .
 - **For dynamic FSR measurements or Variable Controls,** a current-to-voltage converter (see pages 20 and 21) is recommended. This circuit produces an output voltage that is inversely proportional to FSR resistance. Since the FSR resistance is roughly inversely proportional to applied force, the end result is a direct proportionality between force and voltage; in other words, this circuit gives roughly linear increases in output voltage for increases in applied force. This linearization of the response optimizes the resolution and simplifies data interpretation.
 - **For position and force measurement with Linear Potentiometers,** use the circuits detailed on pages 23 to 26.
 5. **Develop a Nominal Voltage Curve and Error Spread.**
When a repeatable and reproducible system has been established, data from a group of FSR parts can be collected. Test several FSR parts in the system. Record the output voltage at various pre-selected force points throughout the range of interest. Once a family of curves is obtained, a nominal force vs. output voltage curve and the total force accuracy of the system can be determined.
 6. **Use Part Calibration if Greater Accuracy is Required.**
For applications requiring the highest obtainable force accuracy, part calibration will be necessary. Two methods can be utilized: gain and offset trimming, and curve fitting.
 - **Gain and offset trimming can be used as a simple method of calibration.** The reference voltage and feedback resistor of the current-to-voltage converter are adjusted for each FSR to pull their responses closer to the nominal curve.
 - **Curve fitting is the most complete calibration method.** A parametric curve fit is done for the nominal curve of a set of FSR devices, and the resultant equation is stored for future use. Fit parameters are then established for each individual FSR (or sensing element in an array) in the set. These parameters, along with the measured sensor resistance (or voltage), are inserted into the equation to obtain the force reading. If needed, temperature compensation can also be included in the equation.
 7. **Refine the System.**
Spurious results can normally be traced to sensor error or system error. If you have any questions, contact Interlink Electronics' Sales Engineers to discuss your system and final data.

FSR Usage Tips

The Do's and Don'ts

Do's

- Do follow the seven steps of the FSR Integration Guide.
- Do, if possible, use a firm, flat and smooth mounting surface.
- Do be careful if applying FSR devices to curved surfaces. Pre-loading of the device can occur as the two opposed layers are forced into contact by the bending tension. The device will still function, but the dynamic range may be reduced and resistance drift could occur. The degree of curvature over which an FSR can be bent is a function of the size of the active area. The smaller the active area, the less effect a given curvature will have on the FSR's response.
- Do avoid air bubbles and contamination when laminating the FSR to any surface. Use only thin, uniform adhesives, such as Scotch® brand double-sided laminating adhesives. Cover the entire surface of the sensor.
- Do be careful of kinks or dents in active areas. They can cause false triggering of the sensors.
- Do protect the device from sharp objects. Use an overlay, such as a polycarbonate film or an elastomer, to prevent gouging of the FSR device.
- Do use soft rubber or a spring as part of the actuator in designs requiring some travel.

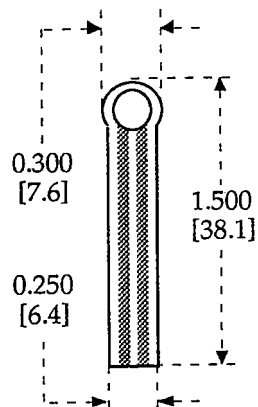
Don'ts

- Do not kink or crease the tail of the FSR device if you are bending it; this can cause breaks in the printed silver traces. The smallest suggested bend radius for the tails of evaluation parts is about 0.1" [2.5 mm]. In custom sensor designs, tails have been made that bend over radii of 0.03" [0.8 mm]. Also, be careful if bending the tail near the active area. This can cause stress on the active area and may result in pre-loading and false readings.
- Do not block the vent. FSR devices typically have an air vent that runs from the open active area down the length of the tail and out to the atmosphere. This vent assures pressure equilibrium with the environment, as well as allowing even loading and unloading of the device. Blocking this vent could cause FSRs to respond to any actuation in a non-repeatable manner. Also note, that if the device is to be used in a pressure chamber, the vented end will need to be kept vented to the outside of the chamber. This allows for the measurement of the differential pressure.
- Do not solder directly to the exposed silver traces. With flexible substrates, the solder joint will not hold and the substrate can easily melt and distort during the soldering. Use Interlink Electronics' standard connection techniques, such as solderable tabs, housed female contacts, Z-axis conductive tapes, or ZIF (zero insertion force) style connectors.
- Do not use cyanoacrylate adhesives (e.g. Krazy Glue®) and solder flux removing agents. These degrade the substrate and can lead to cracking.
- Do not apply excessive shear force. This can cause delamination of the layers.
- Do not exceed 1 mA of current per square centimeter of applied force (actuator area). This can irreversibly damage the device.

Evaluation Parts

Descriptions and Dimensions

Part #300 (1/5" Circle)



Active Area 0.2" [5.0] diameter

Nominal Thickness 0.010" [0.25]

Material Build:

Semiconductive Layer

0.004" [0.10] PES

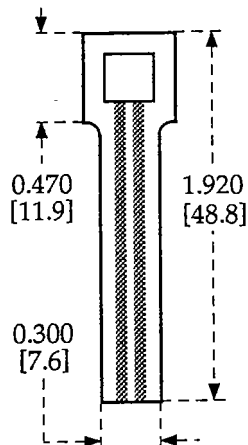
Spacer Adhesive

0.002" [0.05] Acrylic

Silver Layer

0.004" [0.10] PES

Part #301 (1/4" Square)



Active Area 0.25" [6.3] x 0.25" [6.3]

Nominal Thickness 0.014" [0.36]

Material Build:

Semiconductive Layer

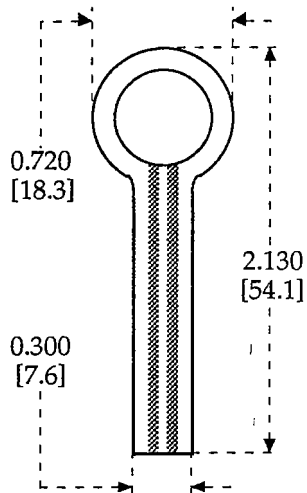
0.005" [0.13] Ultem (PEI)

Spacer Adhesive

0.004" [0.10] Acrylic/polyester

Silver Layer

0.005" [0.13] Ultem (PEI)

Part #302 (1/2" Circle – Ultem)

Active Area 0.5" [12.7] Diameter

Nominal Thickness 0.014" [0.36]

Material Build:**Semiconductive Layer**

0.005" [0.13] Ultem (PEI)

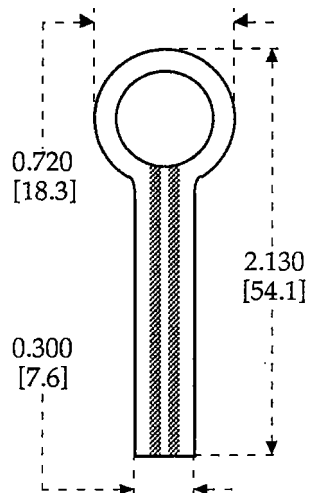
Spacer Adhesive

0.004" [0.10] Acrylic/polyester

Silver Layer

0.005" [0.13] Ultem (PEI)

Note: Although #302 and #303 are the same design, #302 is made with Ultem, a base film that is amber in color, somewhat inflexible, and very environmentally durable; #303 is made with PES, a base film that is transparent, thinner, more flexible, less chemically resistant, and slightly more sensitive to low forces than the Ultem based version.

Part #303 (1/2" Circle – Stabar)

Active Area 0.5" [12.7] Diameter

Nominal Thickness 0.012" [0.30]

Material Build:**Semiconductive Layer**

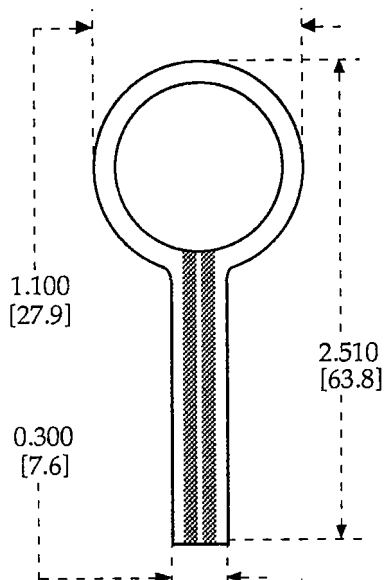
0.004" [0.10] PES

Spacer Adhesive

0.004" [0.10] Acrylic/polyester

Silver Layer

0.004" [0.10] PES

Part #304 (7/8" Circle)

Active Area 0.875" [22.2] Diameter

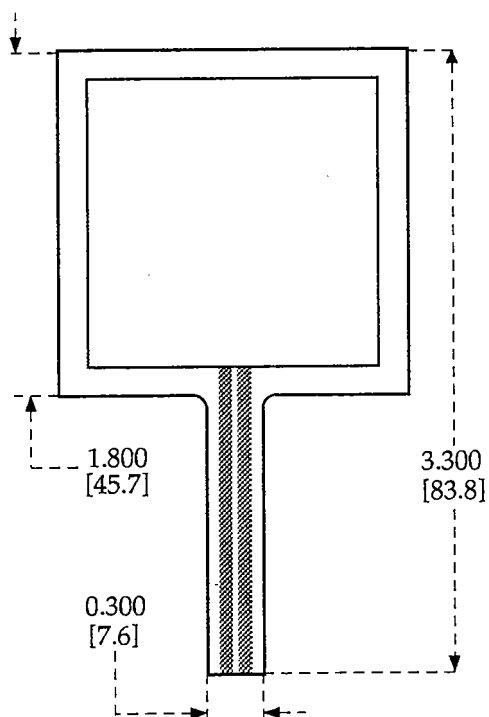
Nominal Thickness 0.017" [0.43]

Material Build:

Semiconductive Layer
0.005" [0.13] Ultem (PEI)

Spacer Adhesive
0.007" [0.17] Acrylic/polyester

Silver Layer
0.005" [0.13] Ultem (PEI)

Part #306 (1-1/2" Square)

Active Area 1.5" [38.1] x 1.5" [38.1]

Nominal Thickness 0.017" [0.43]

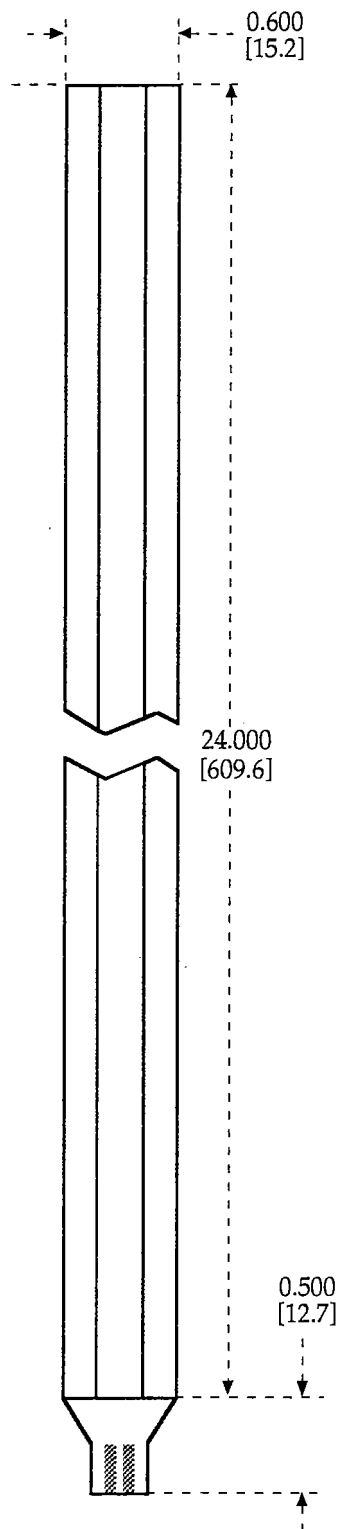
Material Build:

Semiconductive Layer
0.005" [0.13] Ultem (PEI)

Spacer Adhesive
0.007" [0.17] Acrylic/polyester

Silver Layer
0.005" [0.13] Ultem (PEI)

Part #308 (24" Trimmable Strip)



Active Area 24" [609.6] × 0.25" [6.3]

Nominal Thickness 0.010" [0.25]

Material Build:

Semiconductive Layer

0.004" [0.10] PES

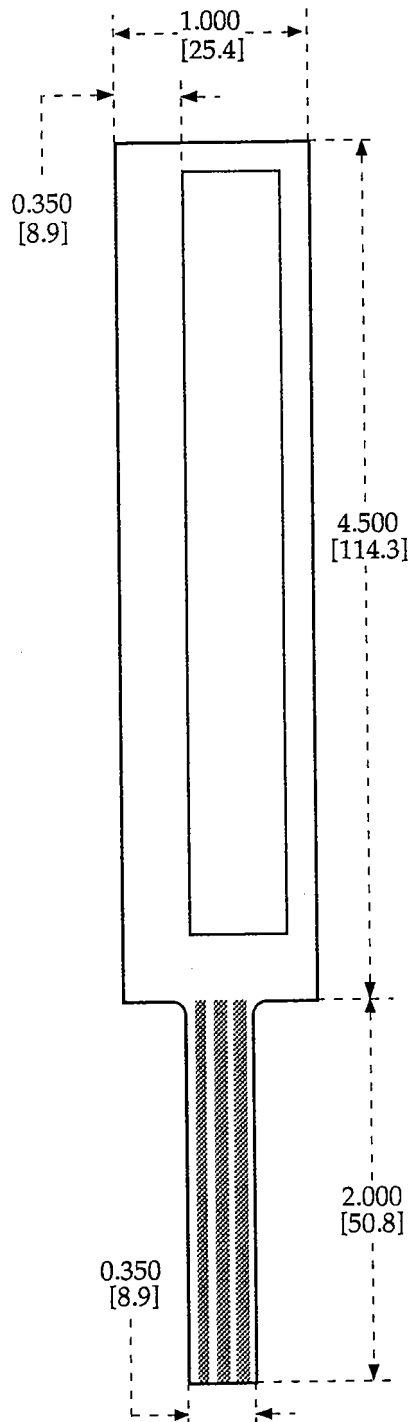
Spacer Adhesive

0.0035" [0.089] Acrylic

Silver Layer

0.004" [0.10] PES

Part #360 (4" Linear Potentiometer)



Active Area 0.5" [12.7] × 4" [101.6]

Nominal Thickness 0.017" [0.43]

Material Build:

Semiconductive Layer
0.005" [0.13] Ultem (PEI)

Spacer Adhesive
0.007" [0.17] Acrylic/polyester

Silver Layer
0.005" [0.13] Ultem (PEI)

General FSR Characteristics

These are typical parameters. The FSR is a custom device and can be made for use outside these characteristics. Consult Sales Engineering with your specific requirements.

Simple FSR Devices and Arrays

Parameter	Value	Notes
Size Range	Max = 20" x 24" (51 x 61 cm) Min = 0.2" x 0.2" (0.5 x 0.5 cm)	Any shape
Device Thickness	0.008" to 0.050" (0.20 to 1.25 mm)	Dependent on materials
Force Sensitivity Range	< 100 g to > 10 kg	Dependent on mechanics
Pressure Sensitivity Range	< 1.5 psi to > 150 psi (< 0.1 kg/cm ² to > 10 kg/cm ²)	Dependent on mechanics
Part-to-Part Force Repeatability	± 15% to ± 25% of established nominal resistance	With a repeatable actuation system
Single Part Force Repeatability	± 2% to ± 5% of established nominal resistance	With a repeatable actuation system
Force Resolution	Better than 0.5% full scale	
Break Force (Turn-on Force)	20 g to 100 g (0.7 oz to 3.5 oz)	Dependent on mechanics and FSR build
Stand-Off Resistance	> 1 MΩ	Unloaded, unbent
Switch Characteristic	Essentially zero travel	
Device Rise Time	1–2 msec (mechanical)	
Lifetime	> 10 million actuations	
Temperature Range	-30°C to +170°C	Dependent on materials
Maximum Current	1 mA/cm ² of applied force	
Sensitivity to Noise/Vibration	Not significantly affected	
EMI/ESD	Passive device—not damaged by EMI or ESD	
Lead Attachment	Standard flex circuit techniques	

For Linear Pots

Parameter	Value	Notes
Positional Resolution	0.003" to 0.02" (0.075 to 0.5 mm)	Dependent on actuator size
Positional Accuracy	better than ± 1% of full length	

FSR terminology is defined on pages 13 and 14 of this guide.

The product information contained in this document is designed to provide general information and guidelines only and must not be used as an implied contract with Interlink Electronics. Acknowledging our policy of continual product development, we reserve the right to change without notice any detail in this publication. Since Interlink Electronics has no control over the conditions and method of use of our products, we suggest that any potential user confirm their suitability before adopting them for commercial use.

Glossary of Terms

Active Area	The area of an FSR device that responds to normal force with a decrease in resistance.
Actuator	The object which contacts the sensor surface and applies force to FSRs.
Applied Force	The force applied by the actuator on the active area of the sensor.
Array	Any grouping or matrix of FSR sensors which can be individually actuated and measured.
Break Force	The minimum force required, with a specific actuator size, to cause the onset of the FSR response.
Cross-talk	Measurement noise or inaccuracies of a sensor as a result of the actuation of another sensor on the same substrate. See also false triggering.
Drift	The change in resistance with time under a constant (static) load. Also called resistance drift.
Durometer	The measure of the hardness of rubber.
EMI	Electromagnetic interference.
ESD	Electrostatic discharge.
False Triggering	The unwanted actuation of a FSR device from unexpected stimuli; e.g., bending or cross-talk.
Fixed Resistor	The printed resistor on linear potentiometers that is used to measure position.
Footprint	Surface area and force distribution of the actuator in contact with the sensor surface.
Force Resolution	The smallest measurable difference in force.
FPSR	Force and Position Sensing Resistor. Force sensing linear potentiometers.
FSR™	Force Sensing Resistors®. A polymer thick film device which exhibits a decrease in resistance with an increase in force applied normal to the device surface.
Graphic Overlay	A printed substrate that covers the FSR. Usually used for esthetics and protection.
Housed Female Connector	A stitched on AMP connector with a receptacle (female) ending. A black plastic housing protects the contacts. Suitable for removable ribbon cable and header pin attachment.
Hysteresis	In a dynamic measurement, the difference between instantaneous force measurements at a given force for an increasing load versus a decreasing load.
Interdigitating Electrodes	The conductor grid. An interweaving pattern of linearly offset conductor traces used to achieve electrical contact. This grid is shunted by the semiconductor layer to give the FSR response.
Lead Out or Busing System	The method of electrically accessing each individual sensor.

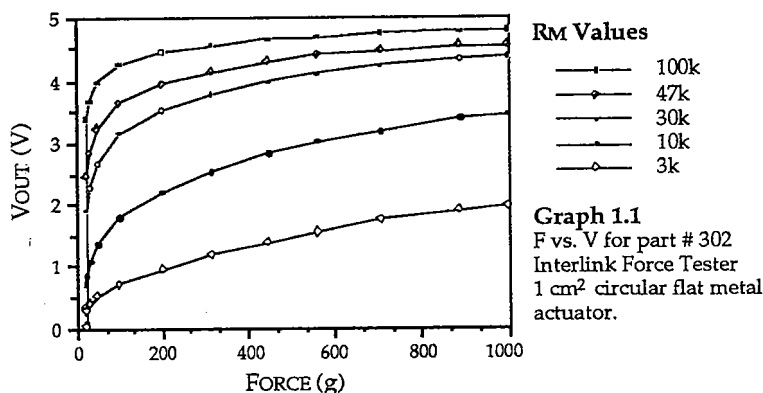
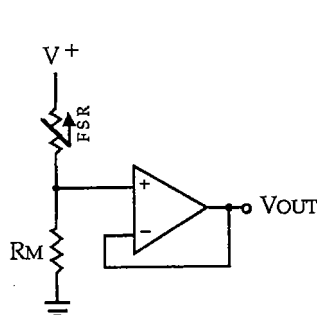
Lexan®	Polycarbonate. A substrate used for graphic overlays and labels. Available in a variety of surface textures.
Linear Potentiometer (LP)	A FSR device which simultaneously measures force and position of an actuator along a line.
Melinex®	A brand of polyester (PET). A substrate with lower temperature resistance than Ultem® or PES, but with excellent flexibility and low cost. Similar to Mylar™.
Part or Device	The FSR. Consists of the FSR semiconductive material, conductor, adhesives, graphics or overlays, and connectors.
PES	Polyethersulfone. A transparent substrate with excellent temperature resistance, moderate chemical resistance, and good flexibility.
Pin Out	The description of a FSR's electrical access at the connector pads (tail).
Positional Accuracy	For LPs, the ability to measure the absolute position of a given force.
Positional Resolution	Also for LPs, the smallest measurable difference in position.
Repeatability	The ability to repeat, within a tolerance, a previous response characteristic.
Response Characteristic	The relationship of force or pressure vs. resistance.
Saturation Pressure	The pressure level beyond which the FSR response characteristic deviates from its inverse power law characteristic. Past the saturation pressure, increases in force yield little or no decrease in resistance.
Sensor	Each area of the FSR device that is independently force sensitive (as in an array).
Solder-tabs	Stitched on AMP connectors with tab endings. Suitable for direct PC board connection or for soldering to wires.
Space and Trace	The widths of the gaps and fingers of the conductive grid; also called pitch.
Spacer Adhesive	The adhesive used to laminate FSR devices together. Dictates stand-off.
Stand-off	The gap or distance between the opposed polymer film layers when the sensor is unloaded and unbent.
Stand-off Resistance	The FSR resistance when the device is unloaded and unbent.
Substrate	Any base material on which the FSR semi-conductive or metallic polymers are printed. (For example, polyetherimide, polyethersulfone and polyester films).
Tail	The region where the lead out or busing system terminates. Generally, the tail ends in a connector.
Ultem®	Polyetherimide (PEI). A yellow, semi-transparent substrate with excellent temperature and chemical resistance and limited flexibility.

Interlink Electronics holds international patents for its Force Sensing Resistor technology.

FSR is a trademark and Force Sensing Resistors is a registered trademark of Interlink Electronics. Interlink and the six dot logotype are registered marks of Interlink Electronics.

Ultem and Lexan are registered trademarks of G.E., Melinex is a registered trademark of ICI, and Mylar is a trademark of E.I. Dupont & Co.

Basic FSRs



FSR Voltage Divider

For a simple force-to-voltage conversion, the FSR device is tied to a measuring resistor in a voltage divider configuration. The output is described by the equation:

$$V_{OUT} = (V+) / [1 + R_{FSR}/R_M]$$

In the shown configuration, the output voltage increases with increasing force. If RFSR and RM are swapped, the output swing will decrease with increasing force. These two output forms are mirror images about the line $V_{OUT} = (V+)/2$.

The measuring resistor, RM, is chosen to maximize the desired force sensitivity range and to limit current. The current through the FSR should be limited to less than 1 mA/square cm of applied force. Suggested op-amps for single sided supply designs are LM358 and LM324. FET input devices such as LF355 and TL082 are also good. The low bias currents of these op-amps reduce the error due to the source impedance of the voltage divider.

A family of FORCE vs. VOUT curves is shown on Graph 1.1 for a standard FSR in a voltage divider configuration with various RM resistors. A (V+) of +5V was used for these examples.

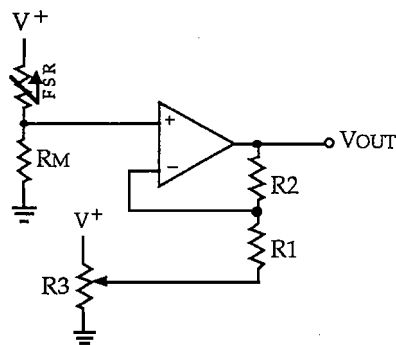


Figure 1.1

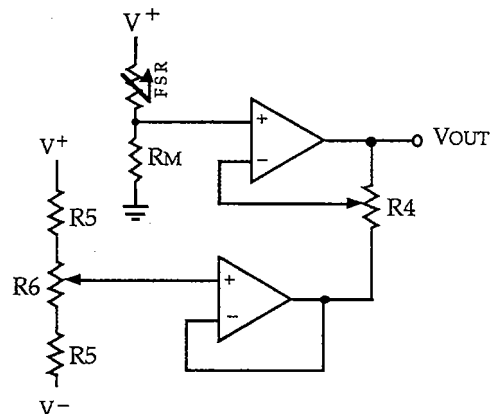


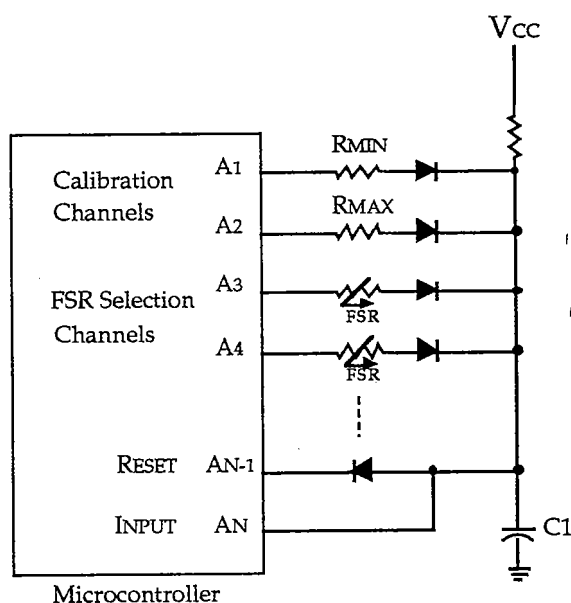
Figure 1.2

Adjustable Buffers

Similar to the FSR Voltage Divider, these interfaces isolate the output from the high source impedance of the Force Sensing Resistor. However, these alternatives allow adjustment of the output offset and gain.

In Figure 1.1, the ratio of resistors R_2 and R_1 sets the gain of the output. Offsets resulting from the non-infinite FSR resistance at zero force (or bias currents) can be trimmed out with the potentiometer, R_3 . For best results, R_3 should be about one-twentieth of R_1 or R_2 . Adding an additional pot at R_2 makes the gain easily adjustable. Broad range gain adjustment can be made by replacing R_2 and R_1 with a single pot.

The circuit in Figure 1.2 yields similar results to the previous one, but the offset trim is isolated from the adjustable gain. With this separation, there is no constraint on values for the pot. Typical values for R_5 and the pot are around $10\text{k}\Omega$.



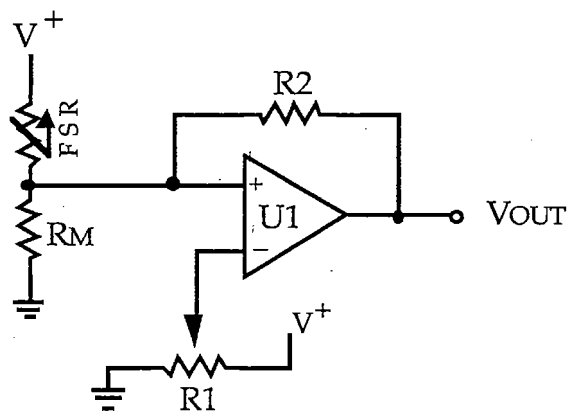
Multi-Channel FSR-to-Digital Interface

Sampling Cycle (any FSR channel):

The microcontroller switches to a specific FSR channel, toggling it high, while all other FSR channels are toggled low. The RESET channel is toggled high, a counter starts and the capacitor C1 charges, with its charging rate controlled by the resistance of the FSR ($t \sim RC$). When the capacitor reaches the high digital threshold of the INPUT channel, the counter shuts off, the RESET is toggled low, and the capacitor discharges.

The number of "counts" it takes from the toggling of the RESET high to the toggling of the INPUT high is proportional to the resistance of the FSR. The resistors R_{MIN} and R_{MAX} are used to set a minimum and maximum "counts" and therefore the range of the "counts". They are also used periodically to re-calibrate the reference. A sampling cycle for R_{MIN} is run, the number of "counts" is stored and used as a new zero. Similarly, a sampling cycle for R_{MAX} is run and the value is stored as the maximum of the range (after subtracting the R_{MIN} value). Successive FSR samplings are normalized to the new zero. The full range is "zoned" by dividing the normalized maximum "counts" by the number of desired zones. This will delineate the window size or width of each zone.

Continual sampling is done to record changes in FSR resistance due to changes in force. Each FSR is selected sequentially.



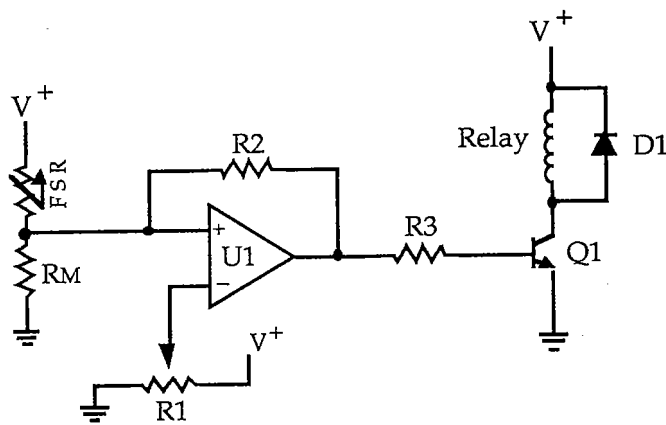
FSR Variable Force Threshold Switch

This simple circuit is ideal for applications that require on-off switching at a specified force, such as touch-sensitive membrane, cut-off, and limit switches. For a variation of this circuit that is designed to control relay switching, see the next page.

The FSR device is arranged in a voltage divider with R_M . An op-amp, U1, is used as a comparator. The output of U1 is either high or low. The non-inverting input of the op-amp is driven by the output of the divider, which is a voltage that increases with force. At zero force, the output of the op-amp will be low. When the voltage at the non-inverting input of the op-amp exceeds the voltage of the inverting input, the output of the op-amp will toggle high. The triggering voltage, and therefore the force threshold, is set at the inverting input by the pot R1. The hysteresis resistor, R2, acts as a "debouncer", eliminating any multiple triggerings of the output that might occur.

Suggested op-amps are LM358 and LM324. Comparators like LM393 and LM339 also work quite well. The parallel combination of R2 with R_M is chosen to limit current and to maximize the desired force sensitivity range. A typical value for this combination is about 47k Ω .

The threshold adjustment pot, R1, can be replaced by two fixed value resistors in a voltage divider configuration.



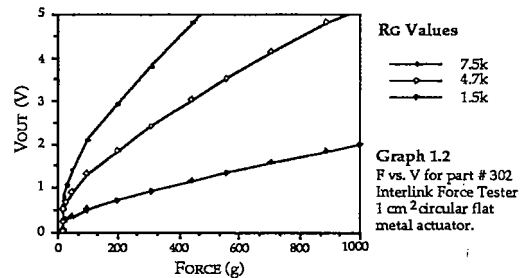
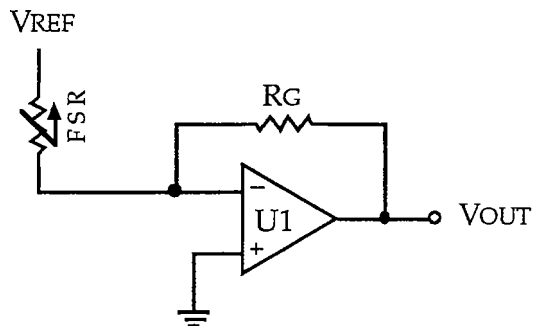
FSR Variable Force Threshold Relay Switch

This circuit is a derivative of the simple FSR Variable Force Threshold Switch on the previous page. It has use where the element to be switched requires higher current, like automotive and industrial control relays.

The FSR device is arranged in a voltage divider with R_M . An op-amp, U1, is used as a comparator. The output of U1 is either high or low. The non-inverting input of the op-amp sees the output of the divider, which is a voltage that increases with force. At zero force, the output of the op-amp will be low. When the voltage at the non-inverting input of the op-amp exceeds the voltage of the inverting input, the output of the op-amp will toggle high. The triggering voltage, and therefore the force threshold, is set at the inverting input by the pot R1. The transistor Q1 is chosen to match the required current specification for the relay. Any medium power NPN transistor should suffice. For example, an NTE272 can sink 2 amps, and an NTE291 can sink 4 amps. The resistor R3 limits the base current (a suggested value is $4.7k\Omega$). The hysteresis resistor, R2, acts as a "debouncer", eliminating any multiple triggerings of the output that might occur.

Suggested op-amps are LM358 and LM324. Comparators like LM393 and LM339 also work quite well, but must be used in conjunction with a pull-up resistor. The parallel combination of R2 with R_M is chosen to limit current and to maximize the desired force sensitivity range. A typical value for this combination is about $47k\Omega$.

The threshold adjustment pot, R1, can be replaced by two fixed value resistors in a voltage divider configuration. The diode D1 is included to prevent flyback, which could harm the relay and the circuitry.



FSR Current-to-Voltage Converter

In this circuit, the FSR device is the input of a current-to-voltage converter. The output of this amplifier is described by the equation:

$$V_{OUT} = V_{REF} \cdot [-R_G / R_{FSR}].$$

With a positive reference voltage, the output of the op-amp must be able to swing below ground, from 0V to -VREF, therefore dual sided supplies are necessary. A negative reference voltage will yield a positive output swing, from 0V to +VREF.

Since this is a simple inverse relation between VOUT and RFSR, the output equation can be rearranged to:

$$V_{OUT} = (-R_G \cdot V_{REF}) / R_{FSR}.$$

VOUT is inversely proportional to RFSR. Changing RG and/or VREF changes the response slope. The following is an example of the sequence used for choosing the component values and output swing:

For a human-to-machine variable control device, like a joystick, the maximum force applied to the FSR is about 1kg. Testing of a typical FSR shows that the corresponding RFSR at 1kg is about 4.6kΩ. If VREF is -5V, and an output swing of 0V to +5V is desired, then RG should be approximately equal to this minimum RFSR. RG is set at 4.7kΩ. A full swing of 0v to +5V is thus achieved. A set of FORCE vs. VOUT curves is shown on Graph 1.2 for a standard FSR using this interface with a variety of RG values.

The current through the FSR device should be limited to less than 1 mA/square cm of applied force. As with the voltage divider circuit, adding a resistor in parallel with RFSR will give a definite rest voltage, which is essentially a zero-force intercept value. This can be useful when resolution at low forces is desired.

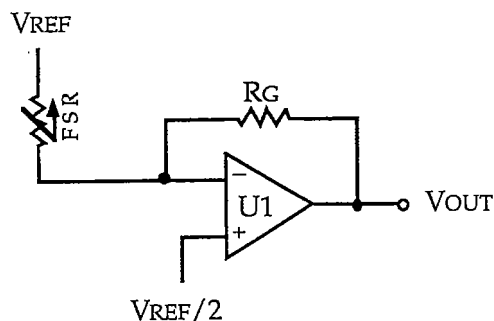


Figure 1.3

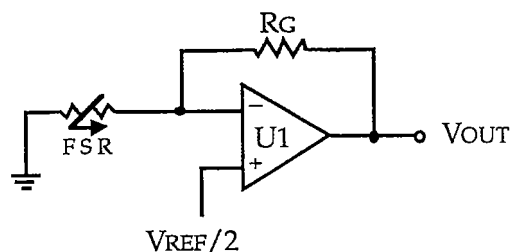


Figure 1.4

Additional FSR Current-to-Voltage Converters

These circuits are a slightly modified versions of the current-to-voltage converter detailed on the previous page. Please refer to it for more detail.

The output of Figure 1.3 is described by the equation:

$$V_{OUT} = V_{REF}/2 \cdot [1 - R_G/R_{FSR}].$$

The output swing of this circuit is from $(V_{REF}/2)$ to 0V. In the case where R_G is greater than R_{FSR} , the output will go into negative saturation.

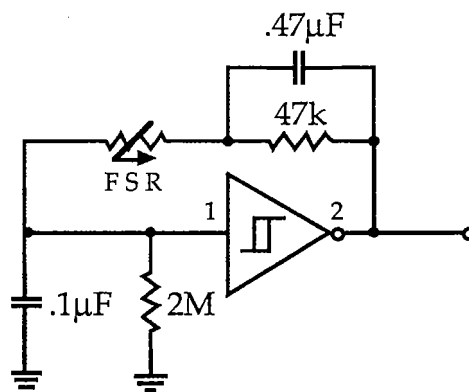
The output of Figure 1.4 is described by the equation:

$$V_{OUT} = V_{REF}/2 \cdot [1 + R_G/R_{FSR}].$$

The output swing of this circuit is from $(V_{REF}/2)$ to V_{REF} . In the case where R_G is greater than R_{FSR} , the output will go into positive saturation.

For either of these configurations, a zener diode placed in parallel with R_G will limit the voltage built up across R_G . These designs yield one-half the output swing of the previous circuit, but only require single sided supplies and positive reference voltages. Like the preceding circuit, the current through the FSR should be limited to less than 1 mA/square cm of applied force.

Suggested op-amps are LM358 and LM324.

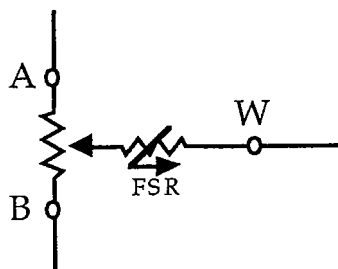


FSR Schmitt Trigger Oscillator

In this circuit, an oscillator is made using the FSR device as the feedback element around a Schmitt Trigger. In this manner, a simple force-to-frequency converter is made. At zero force, the FSR is an open circuit. Depending on the last stage of the trigger, the output remains constant, either high or low. When the FSR is pressed, the oscillator starts, its frequency increasing with increasing force. The 2MΩ resistor at the input of the trigger insures that the oscillator is off when FSRs with non-infinite resistance at zero force are used. The 47kΩ resistor and the 0.47 μF capacitor control the force-to-frequency characteristic. Changes in the "feel" of this circuit can be made by adjusting these values. The 0.1 μF capacitor controls the frequency range of the oscillator. By implementing this circuit with CMOS or TTL, a digital process can be controlled by counting leading and/or trailing edges of the oscillator output. Suggested Schmitt Triggers are CD40106, CD4584 or 74C14.

Linear Potentiometers

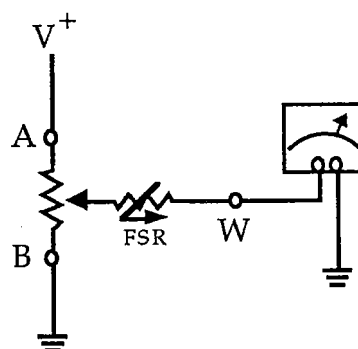
The Interlink Linear Potentiometer



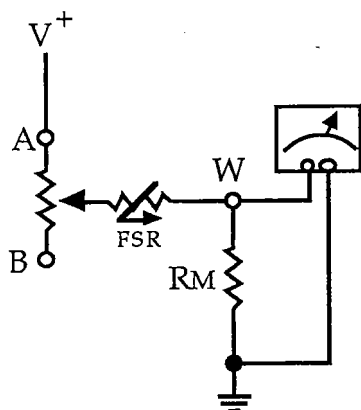
This diagram shows the equivalent circuit for an Interlink LP. The contact points A and B denote the ends of the fixed resistor that is used to measure position. W denotes the momentary wiper contact. The equivalent circuits for force or position sensing are detailed below.

Positional Measurement with the Linear Potentiometer

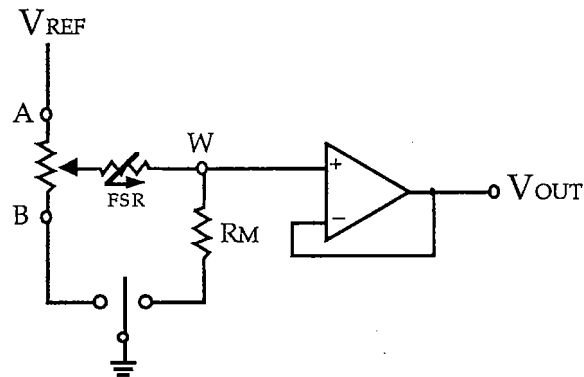
In common LP usage, a voltage is applied across A and B to create a measurable gradient. Thus, the voltage measured at the wiper is proportional to the distance along the LP. If no current is drawn through the FSR device element, positional measurement is made independent of force. A high impedance measuring device, like a digital multimeter, is excellent for positional measurement without force-resistance corruption. Notice that the voltage gradient is independent of the value of the positional resistor. A gradient of $0V$ to $V+$ is established regardless of the positional resistor value. The important resistor parameter is linearity, which is typically better than 1%.



Force Measurement with the Linear Potentiometer



For rough force measurements, a resistor, R_M , is connected in series with the FSR device. This forms a voltage divider with the FSR device and R_M . The voltage measured across R_M is proportional to the force on the LP. Some error is inherent in this force measurement. By following the path of current from $V+$ to ground, it can be seen that, depending on position, more or less of the positional resistor will be in series with R_{FSR} . This added series resistance causes error in the measured output of the voltage divider by position. Some minimization of the force error can be achieved by tying A and B together during force measurement.

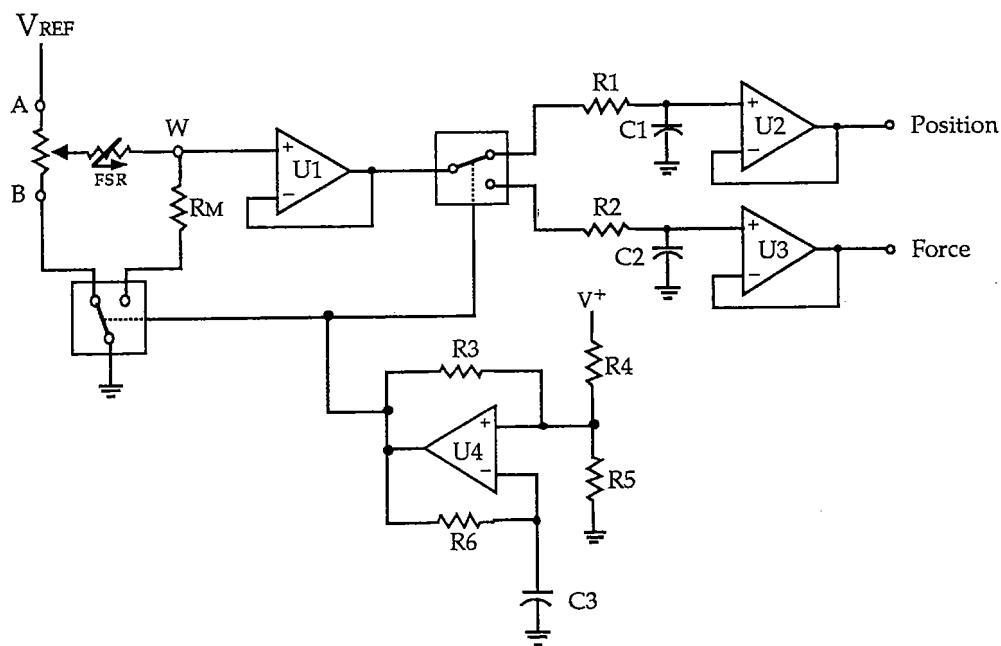


Simple LP Analog Interface (Force or Position)

This interface combines both of the previous circuits. A switch is used to toggle between force and position measurements. A unity gain buffer has been added to isolate the LP from the succeeding circuitry. Additionally, the low input impedance of this buffer keeps current from flowing through the FSR resistor (wiper) during position measurement, and drives current through the voltage divider combination of the FSR resistor, R_M and a segment of the positional resistor during force measurement. See the previous page for more detail.

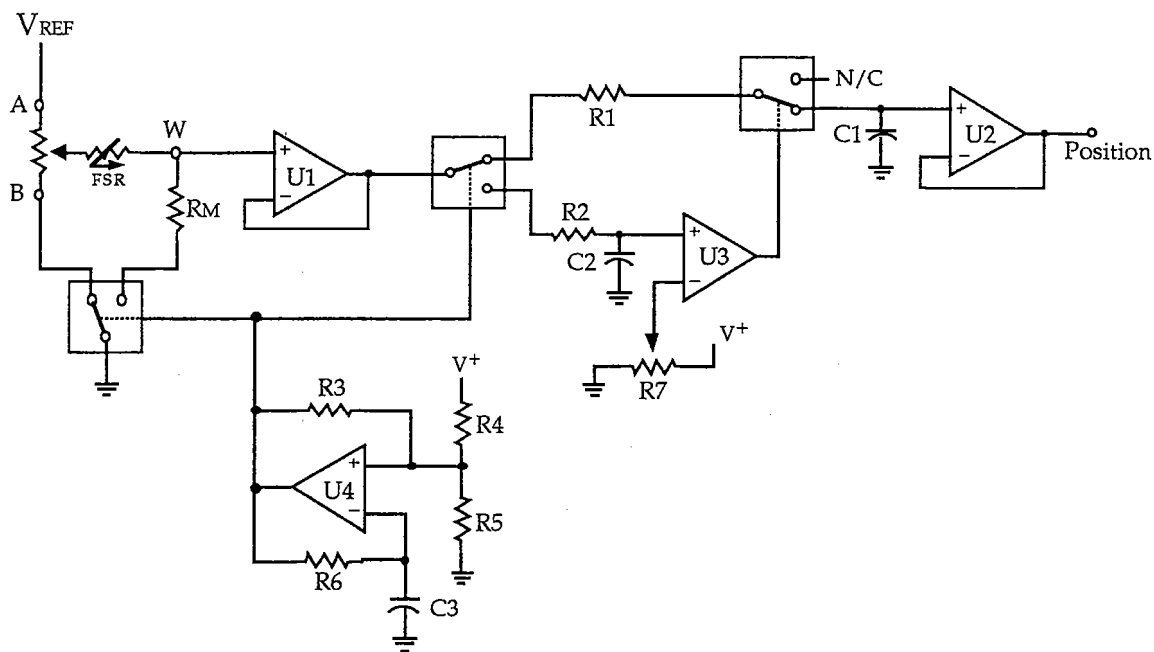
This interface is excellent for measurements against V_{REF} through an A/D.

Suggested op-amps for this buffer are LM358 and LM324. FET input devices such as LF355 and TL072 are also good. Suitable reference voltages for this and similar LP circuits should limit current to below 1mA.



Separated Force and Position Analog LP Interface

This circuit uses a multiplexer to yield nearly simultaneous force and position outputs. The multiplexer is driven by a Schmitt trigger oscillator. The resistor-capacitor combinations (C1-R1; C2-R2) at the non-inverting inputs of the op-amps act as simple sample-and-hold circuits between cycles. These are not necessary if these outputs are going into a microcontroller. This interface utilizes two ICs, a CD4053 and a LM324 (U1-U4).



Position Measuring Analog LP Interface with Force Threshold

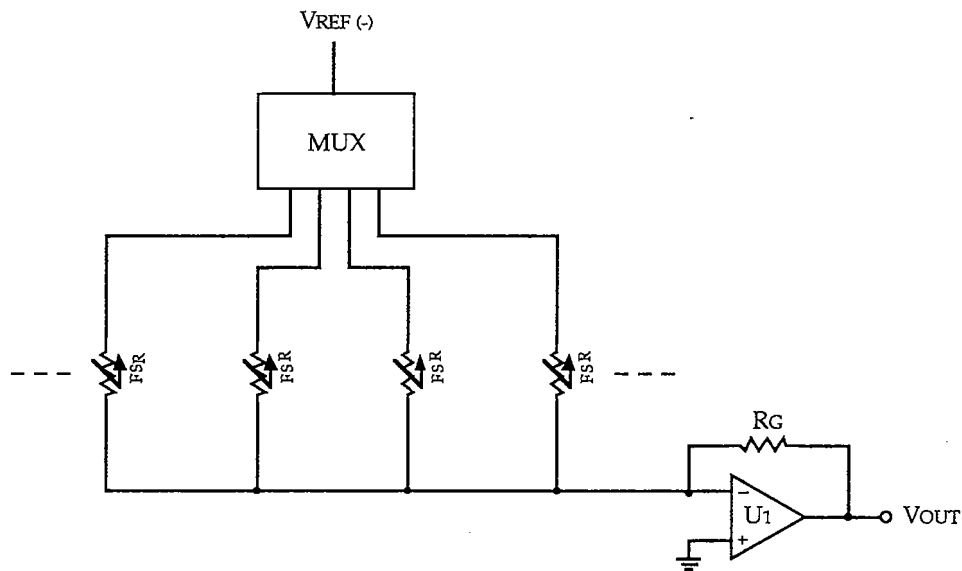
In cases where position is the only desired measurement, this interface is useful. The force sensing aspect is being used to set a force threshold for positional data output. Once the force threshold is exceeded, the output of op-amp U3 goes high and the succeeding multiplexer segment toggles to positional output. This force threshold is adjusted with the pot, R7.

Resistor-capacitor combinations act as simple sample and hold circuits between cycles.

Suggested ICs for this interface are a CD4053 for the multiplexer and a LM324 for the op-amps (U1-U4).

An enhanced sample and hold can be achieved by replacing U2 with a JFET type input op-amp, such as a LF353 or a TL071; this will decrease the leakage of the held value.

Common Bus Arrays



Common Bus Array Current-to-Voltage Converter

For arrays of FSRs that have a single common bus for all of the active areas, this circuit is useful. Based on the current-to-voltage converter, this interface allows the time multiplexed sampling of any number of FSRs in a common bus array.

The performance of the current-to-voltage converter (U1) is described on pages 20 and 21. For a simpler interface, the current-to-voltage converter can be replaced with a voltage divider circuit (see page 15).